

# **RadiaBeam Technologies**

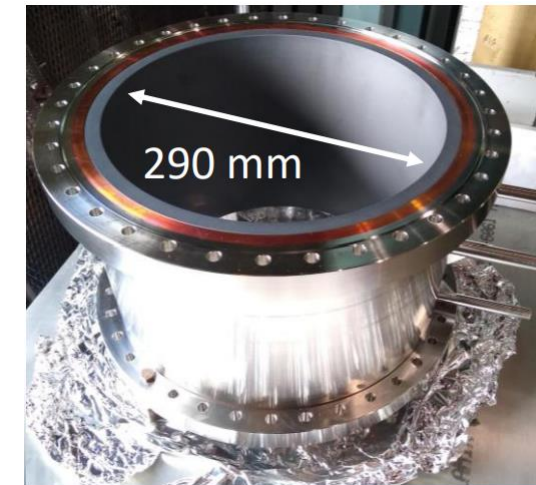
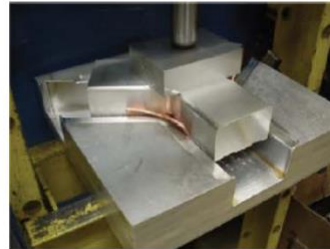
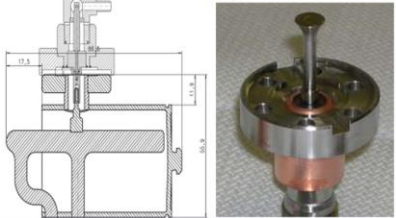
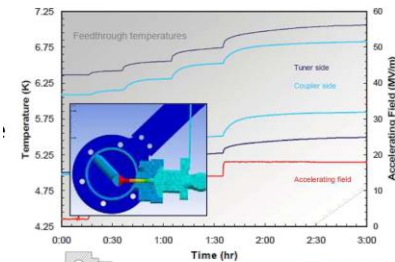
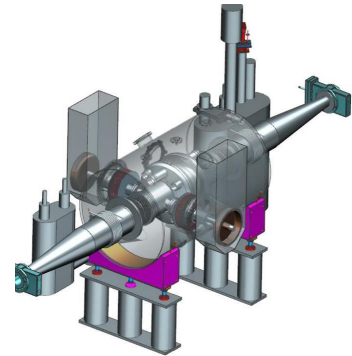
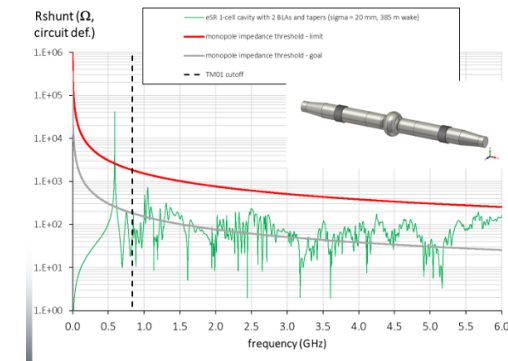
## **Future HOM dampening: EIC & beyond**

**NSAC Long Range Planning Process in the Accelerator Science, Applications and Broader Impacts**

**Nov 15, 2022**

**Dr Paul Carriere, Material & Process Engineer: [carriere@radiabeam.com](mailto:carriere@radiabeam.com)**

- High current or high luminosities: HOM dampers is crucial to absorb the wakefields
  - Does not harm fundamental mode
  - RF Power handling capabilities: [mW] -> [kW]
  - Thermal/mechanical/vacuum/cleanliness considerations
- Design types
  1. Coaxial dampers
  2. Waveguide dampers
  3. **Beampipe/line absorbers(BLA)**



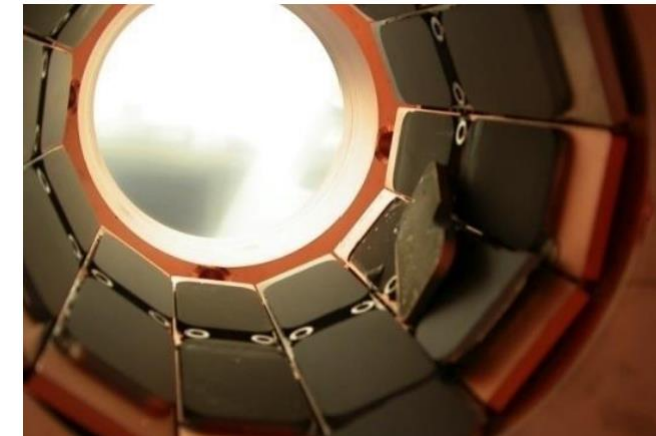
warhauser, "Next generation HOM-damping." *Superconductor Science and Technology* 30.6 (2017): 063002.

Kim 2016 HOM Damping in superconducting harmonic cavity for APS source upgrade

- Various forms of 'industry': R&D focused(\$\$\$) versus production-focused(\$)  
 – Production-focused companies cannot tolerate design changes: quote & build to print  
 – Costs: Project schedule versus budget
- Accelerators: High mix/low volume engineering and production needs  
 – SBIR/STTR projects keep PhD-heavy companies engaged throughout development lifecycle: application-specific challenges
- \$280B CHIPS and Science ACT will impact production-focused companies with applied physics, clean room, chemistry and vacuum expertise  
 – Challenge or opportunity?

HOM Dev	Lab	University	Industry: R&D focus	Industry: Production
1. Conceptual Design	<80%>	<80%>	<b>20%</b>	
2. Mechanical Design	40%	20%	<b>40%</b>	
3. Prototype fabrication	30%	10%	<b>40%</b>	20%
<b>4. Experimental Testing</b>	<b>&lt;50%&gt;</b>	<b>&lt;50%&gt;</b>	<b>30%</b>	<b>20%</b>
5. Production	<20%>		<20%>	80%

*< %> represents shared costs*



Cornell Injector

- Brazed tile delamination
- Electrostatic beam deflection

# Appendix

- **x17** 591MHz single cell cryomodules: 40kW HOM/cavity, >34 need
- Shrink-fit SiC beam line absorbers
  - Cornell-> APS-U -> EIC
  - Metal/ceramic joint formed mechanically: no brazing/reduced cracking
  - Coorstek Ceramic: SC-35 graphite loaded SiC: Optimized for friction/wear properties, not accelerators
- Proof of principle HOM completed: at least 34 more needed

